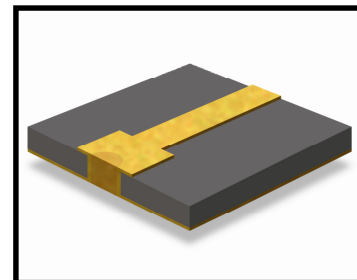


ATP1017 Samples

Polished Aluminum Nitride with Au Solid Filled Vias

Applied Thin-Film Products (ATP) is pleased to provide ceramic thin-film samples for your evaluation.

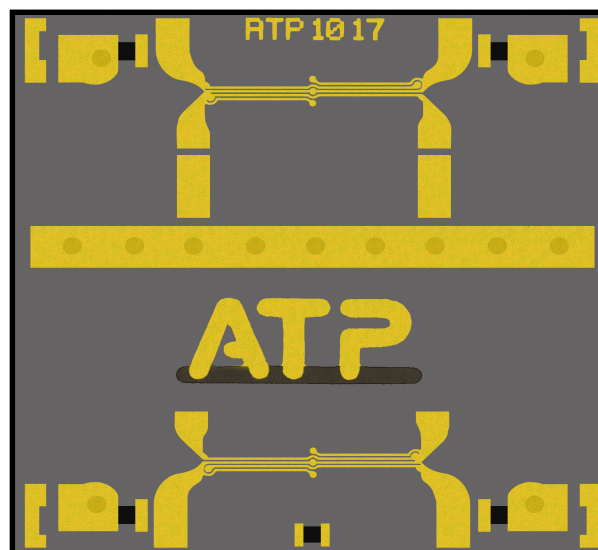
TaN/TiW/Au with solid gold- or copper-filled vias on Aluminum Nitride (AlN). The Au or Cu via is completely filled and polished to provide a planarized surface, providing a low inductance ground path on both sides without venting structures, dissimilar metals or exposed oxides. A filled via can also act as a thermal via or two-sided signal interconnect.



Material Specifications:

Properties	Units	Aluminum Nitride Toshiba
Chemical Composition		AlN
Purity	%	98
Color		Tan
Nominal Density	g/cm	3.28
Surface Finish, Polished	u-inches / nm	< 2.0 / (50nm)
Coefficient of Thermal Expansion (CTE)	10 (-6)	4.6 (25-300 C)
Camber	inches / um(microns)	.0003" / .0005" (7.6/12.7um)
Thickness	inches / um(microns)	.015" (.381mm)
Thickness Tolerance	inches / um(microns)	+/- 0.0005" (+/- 12.7 um)
Thermal Conductivity	Watts/m K	170
Dielectric Constant	1 MHz	8.6
Dissipation Factor (Loss Tangent)	1 MHz	0.001
Hardness	Rockwell	n/a
Flexural Strength	K(10-3) lbs/sq.in	54 (4 pt. Bend)
Compressive Strength	M(10-3) lbs/sq.in.	n/a
Grain Size	um (microns)	5 to 7

Samples Provided:



ATP1017, Material is 15 mil Polished AlN

TaN Resistors = 50 Ohms per Square
 TiW = 400 to 800 Angstroms
 Au = 120 u" minimum

Via Hole Size: .011 +/- .002"

Material Specifications provided by Coors Ceramic Company

ATP offers build-to-print service for a wide range of materials and metalization schemes. ATP fabricates circuits on substrates from As-Fired Alumina to Beryllium Oxide to Fused Silica, even Silicon. Metalizations range from the standard TaN/TiW/Au to films including Nickel, Palladium, Platinum, or Titanium.

At ATP, we constantly evolve our processing and material capabilities to reflect our customer's changing needs. If you have a circuit requirement that is out of the "normal" thin-film type, please contact ATP at (510) 661-4287 or visit our web site www.thinfilm.com. ATP would enjoy discussing your application with you and working to develop a solution.

web site: www.thinfilm.com

